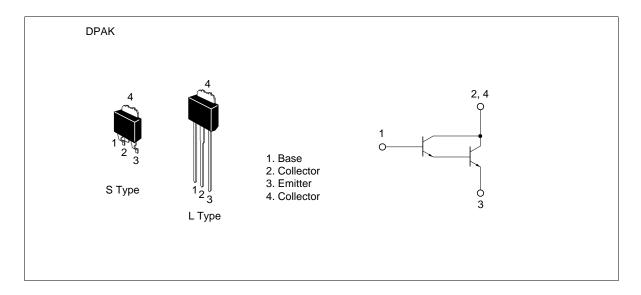
### Silicon NPN Epitaxial

# **HITACHI**

#### **Application**

Low frequency amplifier

#### Outline





#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

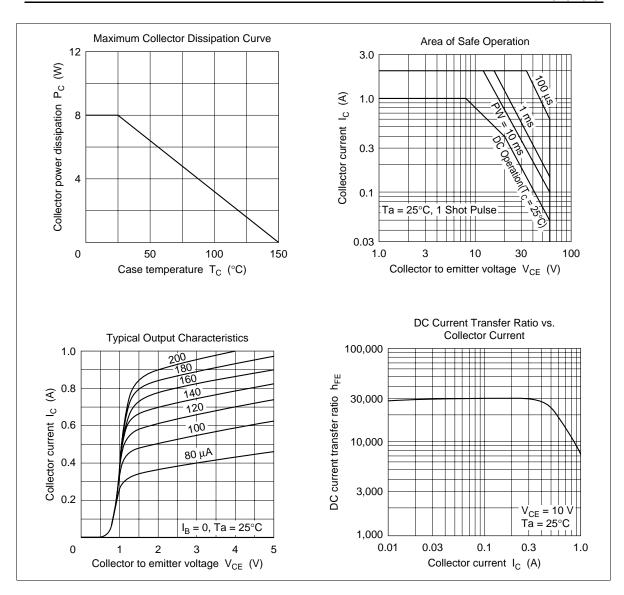
Item	Symbol	Ratings	Unit	
Collector to base voltage	$V_{\text{CBO}}$	60	V	
Collector to emitter voltage	$V_{\text{CEO}}$	60	V	
Emitter to base voltage	$V_{EBO}$	7	V	
Collector current	I <sub>c</sub>	1	А	
Collector peak current	C (peak)	2	А	
Collector power dissipation	P <sub>c</sub>	0.8	W	
	P <sub>c</sub> *1	8		
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

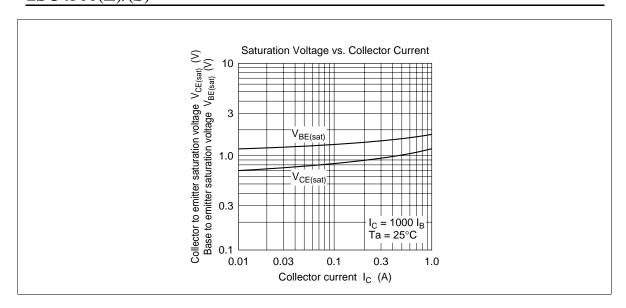
Note: 1. Value at  $T_c = 25^{\circ}C$ .

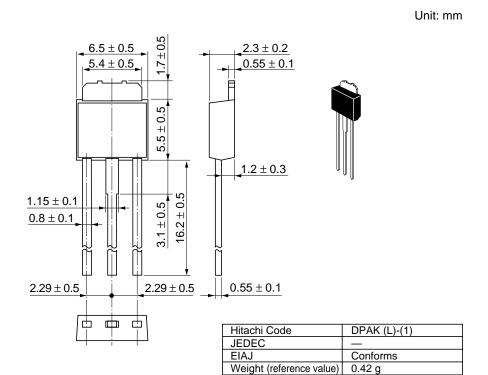
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	60	_	_	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	_	_	V	$I_{\rm E} = 0.1 \text{ mA}, I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	10	μΑ	$V_{CB} = 60 \text{ V}, I_{E} = 0$
DC current transfer ratio	$h_{FE}$	2000	_	_		$V_{CE} = 10 \text{ V}, I_{C} = 500 \text{ mA}^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE (sat)}}$	_	_	1.5	V	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 0.5 \text{ mA}^{*1}$
Base to emitter saturation voltage	V <sub>BE (sat)</sub>	_	_	2.0	V	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 0.5 \text{ mA}^{*1}$
Turn on time	t <sub>on</sub>	_	100	_	ns	$V_{CC} = 12 \text{ V, IC} = 250 \text{ mA},$
Turn off time	t <sub>off</sub>	_	600	_	ns	$I_{B1} = -I_{B2} = 5 \text{ mA}$

Note: 1. Pulse Test.







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